DS30EA101 0.15 to 3.125 Gbps Adaptive Cable Equalizer

Check for Samples: DS30EA101

FEATURES

- **Automatic Equalization of Coaxial and Twisted Pair Cables**
- **Data Rates from 150 Mbps to 3.125 Gbps**
- **Supports SD and HD Video Resolutions**
- **Power Consumption: 115 mW Typical**
- **Industrial Temperature Range: -40°C to +85°C**

APPLICATIONS

- **Cable Extension**
- **Data Recovery Equalization**
- **Security and Surveillance**

DESCRIPTION

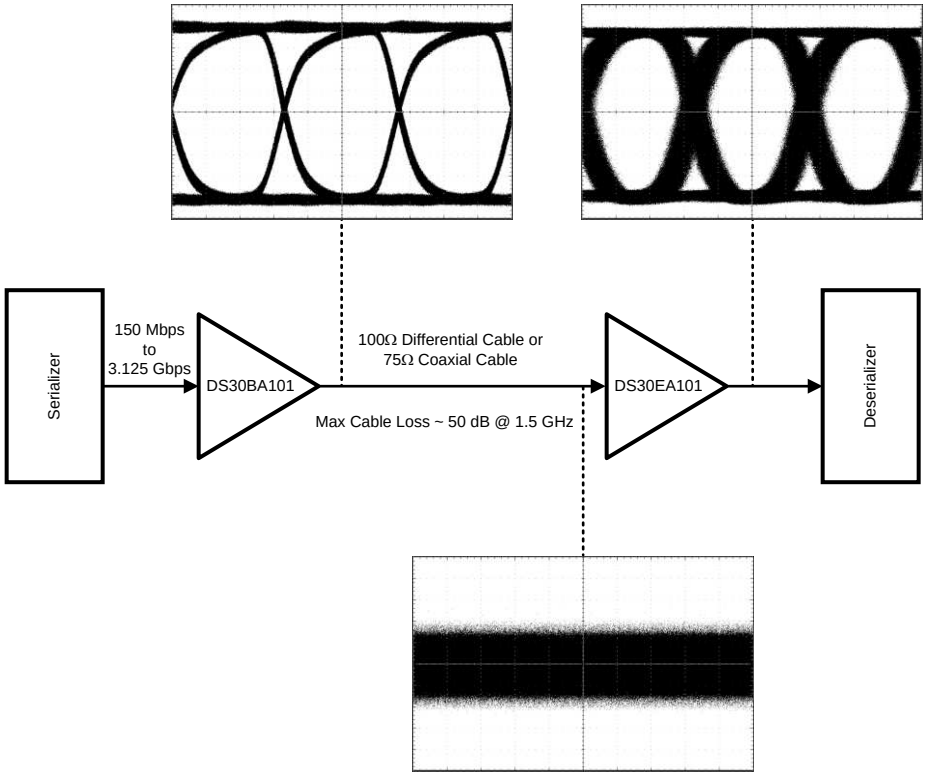
The DS30EA101 is an adaptive cable equalizer optimized for equalizing data transmitted over copper cables. The equalizer operates over a range of data rates from 150 Mbps to 3.125 Gbps and automatically adapts to equalize signals sent over any cable length from zero meters to lengths that attenuate the signal by 50 dB at 1.5 GHz.

The DS30EA101 allows either single-ended or differential input. This enables equalization of signals over coaxial cables as well as twisted pair cables.

Additional features include an LOS detect and output enable which, when tied together, disable the output when no input signal is present.

The DS30EA101 is powered from a single 2.5V supply and consumes 115 mW (typical). It operates over the full industrial temperature range of -40°C to +85°C and is available in a 4 x 4 mm 16-pin WQFN package.

Typical Application



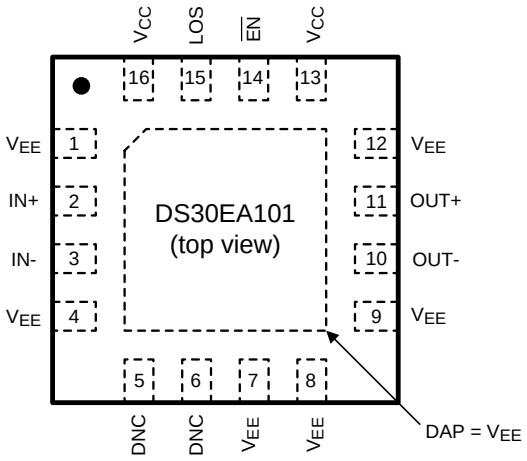
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Connection Diagram



The exposed die attach pad is a negative electrical terminal for this device. It should be connected to the negative power supply voltage.

Figure 1. 16-Pin WQFN Package
See Package Number RUM0016A

PIN DESCRIPTIONS

Pin	Name	I/O, Type	Description
1	V_{EE}	Ground	Negative power supply (ground).
2	IN+	I, Data	Non-inverting input.
3	IN-	I, Data	Inverting input.
4	V_{EE}	Ground	Negative power supply (ground).
5	DNC	N/A	Do not connect – leave open.
6	DNC	N/A	Do not connect – leave open.
7	V_{EE}	Ground	Negative power supply (ground).
8	V_{EE}	Ground	Negative power supply (ground).
9	V_{EE}	Ground	Negative power supply (ground).
10	OUT-	O, LVDS	Inverting output.
11	OUT+	O, LVDS	Non-inverting output.
12	V_{EE}	Ground	Negative power supply (ground).
13	V_{CC}	Power	Positive power supply (+2.5V).
14	$\overline{EN}$	I, LVCMOS	Output enable. LOS may be tied to this pin to inhibit the output when no input signal is present. This pin has an internal pulldown. H = Outputs disabled. L = Outputs enabled.
15	LOS	O, LVCMOS	Loss of signal. H = No input signal detected. L = Input signal detected.
16	V_{CC}	Power	Positive power supply (+2.5V).
DAP	V_{EE}	Ground	Connect exposed DAP to negative power supply (ground).

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings[1]

Supply Voltage	3.1V
Input Voltage (all inputs)	−0.3V to V_{CC}+0.3V
Storage Temperature Range	−65°C to +150°C
Junction Temperature	+125°C
Package Thermal Resistance θ_{JA} 16-pin WQFN θ_{JC} 16-pin WQFN	 +40°C/W +6°C/W
ESD Rating (HBM)	≥±6 kV
ESD Rating (MM)	≥±300V
ESD Rating (CDM)	≥±2 kV

(1) "Absolute Maximum Ratings" indicate limits beyond which damage to the device my occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions.

Recommended Operating Conditions

Supply Voltage (V_{CC})	2.5V ±5%
Input Coupling Capacitance	1.0 µF
Operating Free Air Temperature (T_A)	-40°C to +85°C

DC Electrical Characteristics

Over recommended supply voltage and operating temperature ranges, unless otherwise specified.[1][2]

Parameter		Test Conditions	Reference	Min	Typ	Max	Units
V_{IN}	Input Voltage	0m cable length	IN+, IN-	720	800	880	mV_{P-P}
V_{SS}	Steady State Differential Output Voltage	100Ω load, Figure 2	OUT+, OUT-	500	700	900	mV_{P-P}
V_{OD}	Differential Output Voltage			250	350	450	mV
ΔV_{OD}	Change in Magnitude of V_{OD} for Complimentary Output States					50	mV
V_{OS}	Offset Voltage			1.1	1.2	1.35	V
ΔV_{OS}	Change in Magnitude of V_{OS} for Complimentary Output States					50	mV
I_{OS}	Output Short Circuit Current					30	mA
V_{IH}	Input Voltage High Level		$\overline{EN}$	1.7		V_{CC}	V
V_{IL}	Input Voltage Low Level			V_{EE}		0.7	V
V_{OH}	Output Voltage High Level	I_{OH} = -2 mA	LOS	2.0			V
V_{OL}	Output Voltage Low Level	I_{OL} = +2 mA				0.2	V
I_{CC}	Supply Current				45	65	mA

(1) The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

(2) Typical values represent most likely parametric norms at V_{CC} = +2.5V, T_A = +25°C, and at the Recommended Operating Conditions at the time of product characterization and are not guaranteed.

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AC Electrical Characteristics

Over recommended supply voltage and operating temperature ranges, unless otherwise specified.(1)(2)

Parameter		Test Conditions	Reference	Min	Typ	Max	Units
DR_{IN}	Input Data Rate		IN+, IN-	150		3125	Mbps
t_{JIT}	Total Jitter at BER 10^{-12} (3)	3.125 Gbps, 0-10 meters CAT6			0.35		UI
		2.5 Gbps, 0-25 meters CAT6			0.35		
		1.5 Gbps, 0-50 meters CAT6			0.35		
		3.125 Gbps, 0-100 meters RG59			0.3		
		2.5 Gbps, 0-110 meters RG59			0.35		
		1.5 Gbps, 0-120 meters RG59			0.2		
t_{TLH}	Transition Time Low to High	20% - 80%, 100Ω load, (4), Figure 2	OUT+, OUT-		90	130	ps
t_{THL}	Transition Time High to Low				90	130	ps

(1) The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.
(2) Typical values represent most likely parametric norms at V_{CC} = +2.5V, T_A = +25°C, and at the Recommended Operating Conditions at the time of product characterization and are not guaranteed.
(3) The total jitter at BER 10^{-12} is calculated as DJ + (14 x RJ), where DJ is deterministic jitter and RJ is random jitter. The jitter is expressed as a portion of the unit interval (UI). The UI is the reciprocal of the data rate.
(4) Specification is guaranteed by characterization and is not tested in production.

TIMING DIAGRAMS

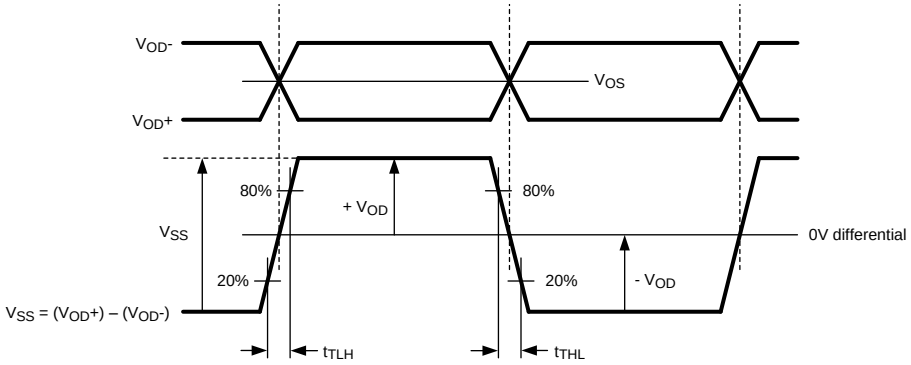


Figure 2. LVDS Output Voltage, Offset, and Timing Parameters

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DEVICE OPERATION

The DS30EA101 equalizes data transmitted over copper cables. It automatically adjusts its gain to reverse the effects of the cable loss and restore the original signal. For proper operation, the launch amplitude of the signal going into the cable (the signal amplitude prior to the cable attenuation) must be set appropriately. If the signal is single-ended, its single-ended amplitude must be 800 mV_{P-P} ±10%. If the signal is differential, its differential amplitude must be 800 mV_{P-P} ±10% (400 mV_{P-P} single-ended).

INPUT INTERFACING

The DS30EA101 accepts either differential or single-ended input. The input must be AC coupled. Figure 3 and Figure 4 show the typical configurations for differential input and single-ended input, respectively. For single-ended input, the unused input must be properly terminated as shown.

OUTPUT INTERFACING

The DS30EA101 output signals (OUT+ and OUT-) are internally terminated 100Ω LVDS outputs. These outputs can be DC coupled to most common differential receivers.

LOS AND $\overline{EN}$

LOS indicates the loss of signal at the DS30EA101 input. LOS is high when no input signal is present and low when a valid input signal is detected.

$\overline{EN}$ can be used to manually disable or enable the OUT+ and OUT- output signals. Applying a high input to $\overline{EN}$ will disable the DS30EA101 outputs by forcing the output to a logic 1, and applying a low input to $\overline{EN}$ will force the outputs to be active. $\overline{EN}$ has an internal pulldown to enable the outputs by default.

LOS and $\overline{EN}$ may be tied together to automatically disable the DS30EA101 outputs when no input signal is present.

Application Information

CABLE EXTENDER APPLICATION

The DS30EA101 together with the DS30BA101 form a cable extender chipset optimized for extending serial data streams from serializer/deserializer (SerDes) pairs and FPGAs over 100Ω differential cables and 75Ω coaxial cables. Setting the correct DS30BA101 output amplitude and proper cable termination are essential for optimal operation. Figure 3 shows the recommended chipset configuration for 100Ω differential cable and Figure 4 shows the recommended chipset configuration for 75Ω coaxial cable.

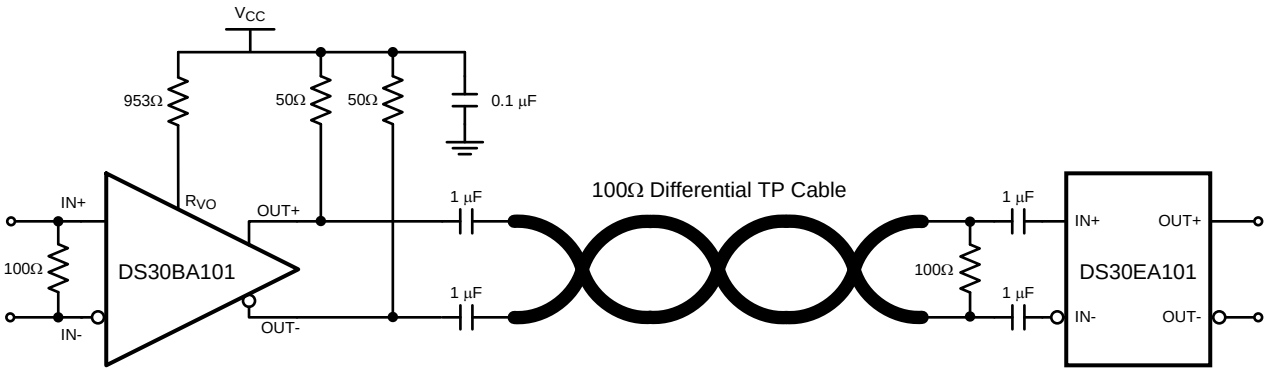


Figure 3. Cable Extender Chipset Application Circuit for 100Ω Differential Cable

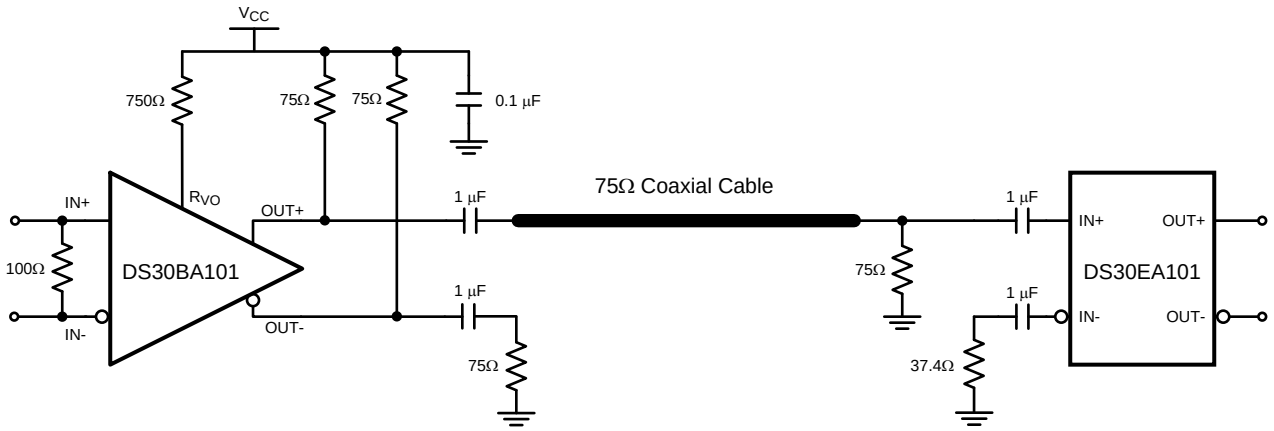


Figure 4. Cable Extender Chipset Application Circuit for 75Ω Coaxial Cable

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
DS30EA101SQ/NOPB	ACTIVE	WQFN	RUM	16	1000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	30EA101	Samples
DS30EA101SQE/NOPB	ACTIVE	WQFN	RUM	16	250	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	30EA101	Samples
DS30EA101SQX/NOPB	ACTIVE	WQFN	RUM	16	4500	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 85	30EA101	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

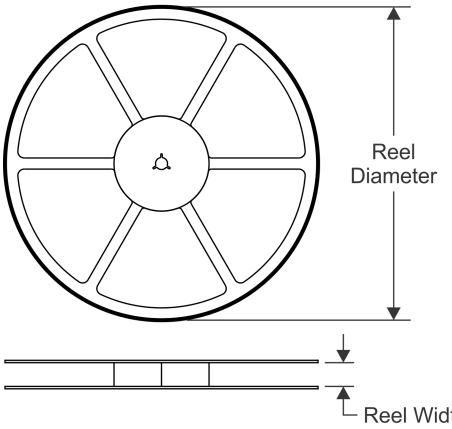
(4) Only one of markings shown within the brackets will appear on the physical device.

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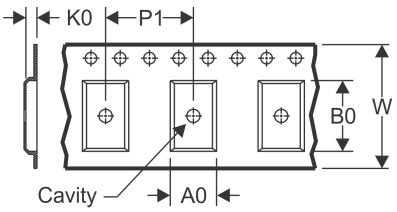
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TAPE AND REEL INFORMATION

REEL DIMENSIONS

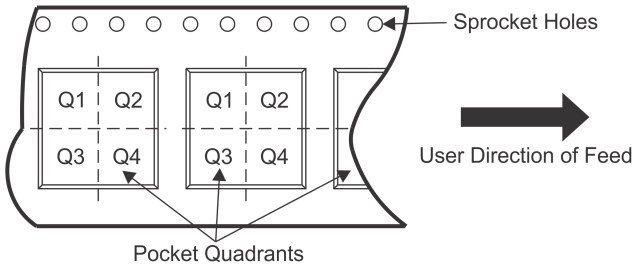


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

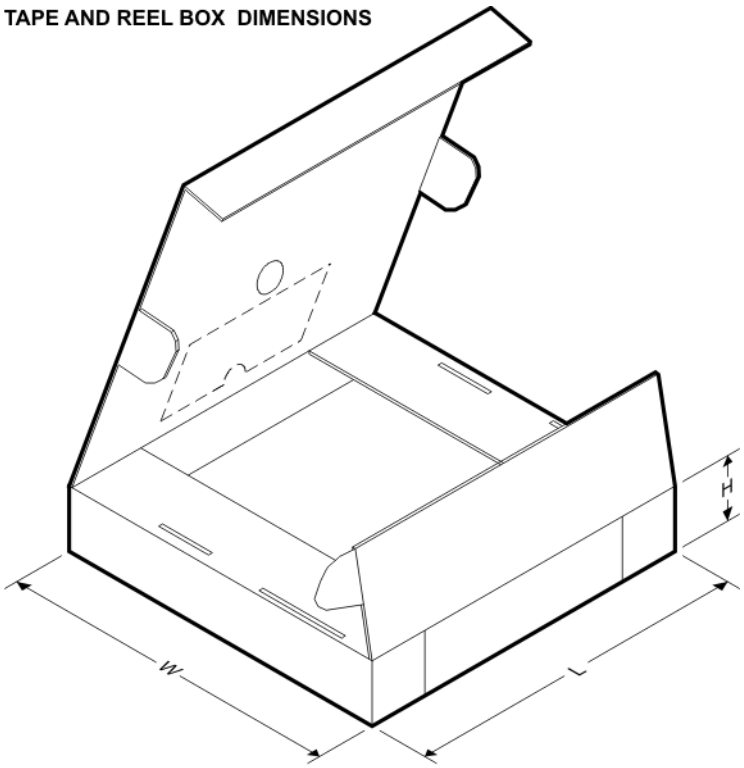
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DS30EA101SQ/NOPB	WQFN	RUM	16	1000	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
DS30EA101SQE/NOPB	WQFN	RUM	16	250	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
DS30EA101SQX/NOPB	WQFN	RUM	16	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1

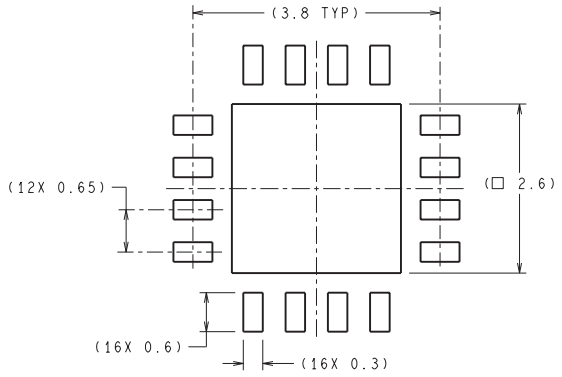
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

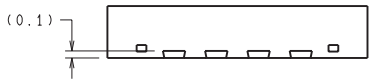
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DS30EA101SQ/NOPB	WQFN	RUM	16	1000	213.0	191.0	55.0
DS30EA101SQE/NOPB	WQFN	RUM	16	250	213.0	191.0	55.0
DS30EA101SQX/NOPB	WQFN	RUM	16	4500	367.0	367.0	35.0

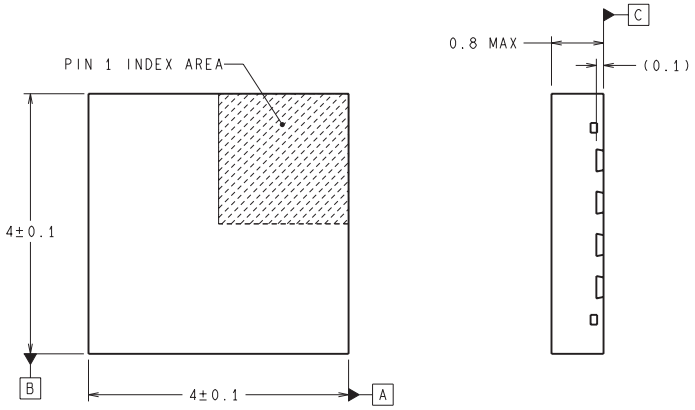
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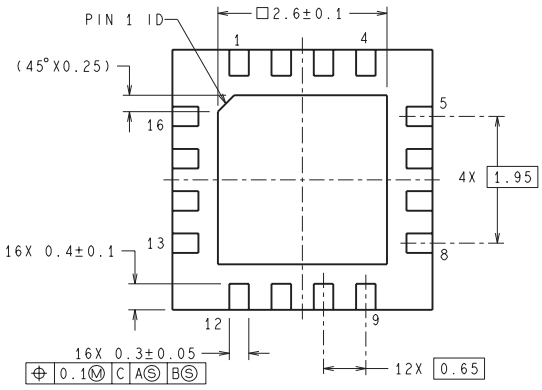


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